

# Low-power MCUs with segment LCD

## Kinetis® K30 Family

The Kinetis Based on the ARM® Cortex®-M4 core, the K30 MCU family offers high-precision analog integration, flexible low-power and peripheral options.

#### **TARGET APPLICATIONS**

- ▶ Thermostats
- ▶ Smart meters
- ▶ Heart rate monitors
- ▶ Blood gas analyzers

Families are built from innovative 90 nm thin-film storage (TFS) flash technology with unique FlexMemory (EEPROM) capability, and offer industry-leading low power and mixed signal analog integration.

The K30 MCU family is pin, peripheral and software compatible with the K10 MCU family and adds a flexible low-power segment LCD controller with support for up to 320 segments. Devices start from 64 KB of flash in 64 LQFN packages extending up to 512 KB in a 144 MAPBGA package with a rich suite of analog, communication, timing and control peripherals.

#### **ONE-STOP ENABLEMENT OFFERING—MCU + IDE + RTOS**

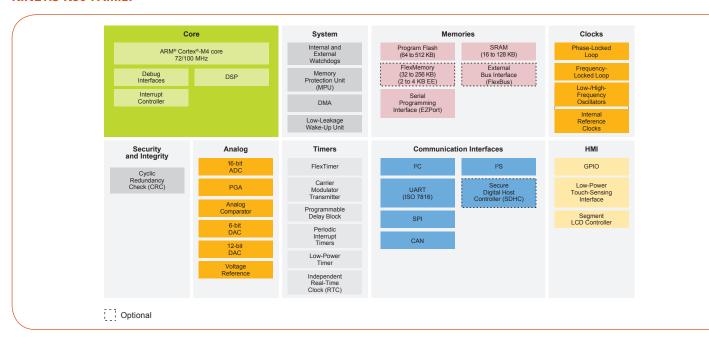
- ▶ Tower® System development board platform
- ▶ Integrated development environments
  - Eclipse-based CodeWarrior® V10.x IDE and Processor Expert®

- IAR Embedded Workbench®
- ARM® Keil® MDK
- Kinetis Design Studio IDE
- ▶ Runtime software and RTOS
  - Math, DSP and encryption libraries
  - Motor control libraries
  - Complimentary bootloaders (USB, Ethernet, RF, serial)
  - Complimentary embedded GUI
  - MQX™ RTOS
  - Micrium<sup>®</sup> μC/OS-III
  - Express Logic ThreadX
  - SEGGER embOS
  - FreeRTOS
- ▶ Full ARM® ecosystem



Features	Benefits
<ul> <li>ARM® Cortex®-M4 core with DSP instruction support</li> <li>Up to 16-channel DMA; crossbar switch</li> </ul>	<ul> <li>Up to 100 MHz core supporting a broad range of processing bandwidth needs</li> <li>Peripheral and memory servicing with reduced CPU loading</li> <li>Concurrent multi-master bus accesses for increased bus bandwidth</li> </ul>
• Flexible, low-power LCD controller with support for up to 320 segments (40 x 8 or 44 x 4)	<ul> <li>LCD blink mode enables low average power while remaining in low-power mode</li> <li>Segment-fail detect guards against erroneous readouts and reduces LCD test costs</li> <li>Frontplane/backplane reassignment provides pin-out flexibility, easing PCB design and allows LCD configuration changes via firmware with no hardware re-work</li> <li>Supports multiple 3 V and 5 V LCD panel sizes with fewer segments (pins) than competitive controllers and no external components</li> <li>Unused LCD pins can be configured as other GPIO functions</li> </ul>
Low-power capacitive touch-sensing interface	Provides a modern upgrade from mechanical to touch keypad, rotary and slider user interfaces and operates in all low-power modes with minimal current added; supports up to 16 inputs
10 ultra-low-power modes with flash programming and analog operation down to 1.71 V     Low-power timer, low-power RTC, low-leakage wake-up unit	<ul> <li>Peripheral activity and wake-up times can be optimized to suit application requirements, enabling extended battery life (Stop currents of &lt;500 nA, run currents of &lt;200 µA/MHz, 4 µs wake-up from Stop)</li> <li>Continual device operation in reduced power states with flexible wake-up options</li> </ul>
Memory protection unit     Hardware cyclic redundancy check engine     Independent-clocked COP; external watchdog monitor	<ul> <li>Provides memory protection for all cross bar switch masters, increasing software reliability</li> <li>Validates memory contents and communication data, increasing system reliability</li> <li>Prevents code runaway in fail-safe applications; drives output pin to safe state external components if watchdog event occurs</li> </ul>
<ul> <li>64–512 KB flash; up to to 128 KB of SRAM</li> <li>32–256 KB FlexMemory</li> </ul>	<ul> <li>High reliability, fast access program memory with four levels of security protection. Independent flash banks allow concurrent code execution and firmware updating</li> <li>FlexMemory provides 32 bytes-4 KB of user-segmentable byte write/erase EEPROM</li> <li>FlexNVM 32-256 KB for extra program code, data or EEPROM backup</li> </ul>

#### **KINETIS K30 FAMILY**



### **KINETIS K30 FAMILY OPTIONS**

	Memory				Feature Options								Packages					
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Part Number	CPU (MHz)	Flash (KB)	Flex NVM (KB)	SRAM (KB)	Memory Protection Unit	CAN	Secure Digital Host Controller	External Bus Interface	12-bit DAC	Prog. Gain Amplifier	5 V Tolerant I/O	Other	64 LQFP (10 x 10)	80 LQFP (12 x 12)	100 LQFP (14 x 14)	121 BGA (8 x 8)	144 LOFP (20 x 20)	144 BGA (13 x 13)
MK30DN512Vyy10	100	512		128	V	1	√	*	1	1	J	Segment LCD (up to 40 x 8/44 x 4)		1	1	<b>√</b>	<b>√</b>	1
MK30DX64Vyy7	72	64	32	16		1			1	1	1	Segment LCD (up to 24 x 8/28 x 4)	1	1		1		
MK30DX128Vyy7	72	128	32	32		1			1	1	J	Segment LCD (up to 38 x 8/42 x 4)	1	1	1	1		
MK30DX256Vyy7	72	256	32	64		1			1	1	1	Segment LCD (up to 38 x 8/42 x 4)		1	1	1		
MK30DX128yy10	100	128	128	32	1	1	1	1	1	<b>√</b>	1	Segment LCD (up to 40 x 8/44 x 4)					<b>√</b>	1
MK30DX256yy10	100	256	256	64	J	1	J	1	1	1	J	Segment LCD (up to 40 x 8/44 x 4)					J	1

yy = Package designator \*144pin only